

Film capacitors

Metallized polypropylene film capacitors (MKP)

Series/Type: B32774 ... B32778

Date: December 2023

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B32774 ... B32778

MKP DC link - high density series up to 480 µF

Typical applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1:2013): 40/105/56

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance values up to 480 µF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

Delivery mode

Bulk (untaped)



Metallized polypropylene film capacitors (MKP)
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B32774 ... B32778

MKP DC link – high density series up to 480 μ F

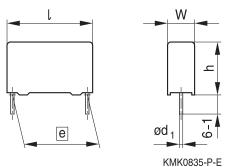
Dimensional drawings

Number of wires	Lead spacing e ±0.4	Lead diameter d ₁ ±0.05	Туре
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E
2-pin	37.5	1.0	B32776T
4-pin	37.5	1.2	B32776G
4-pin	37.5	1.2	B32776T
4-pin	52.5	1.2	B32778T
4-pin	52.5	1.2	B32778G
12-pin	52.5	1.2	B32778J

Dimensions in mm

Dimensional drawings 2-pin versions

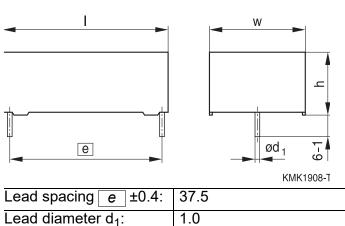
B32774D, B32776E



130	1100000 1 2			
	B32774D	B32776E		
Lead spacing e ±0.4:	27.5	37.5		
Lead diameter d ₁ :	0.8	1.0		

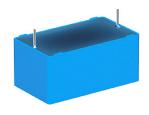
Dimensions in mm

B32776T (low profile)





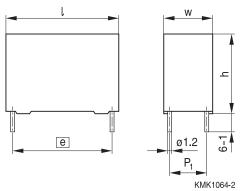




MKP DC link – high density series up to 480 μ F

Dimensional drawings 4-pin versions

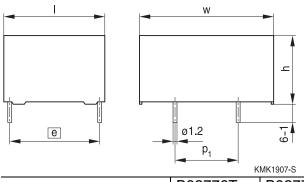
B32776G, B32778G



	B32776G	B32778G
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d ₁ :	1.2	1.2

Dimensions in mm

B32776T, B32778T (low profile)

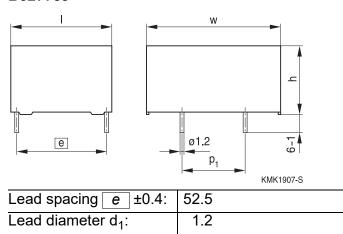


	B32776T	B32778T
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d ₁ :	1.2	1.2

Dimensions in mm

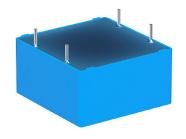
Dimensional drawing 12-pin version

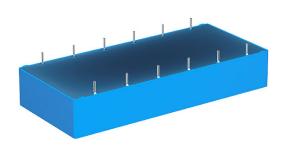
B32778J



Dimensions in mm









B32774 ... B32778

MKP DC link – high density series up to 480 μ F

Overview of available types

Lead spacing	27.5 r	nm			37.5 mm					
Туре	B3277	74			B32776					
Page	7				8					
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C _R (µF)										
1.5										
2.0										
2.7										
3.0										
3.3										
3.5										
3.9										
5.0										
6.8										
7.0										
7.5										
8.0										
8.5										
9.0										
10										
12										
13										
14										
15										
16										
20										
22										
25										
27										
30										
35										
40										
45										
50										
60										
60 65										



B32774 ... B32778

MKP DC link – high density series up to 480 μ F

Overview of available types

Lead spacing	52.5 mm					·
Туре	B32778					
Page	11					
V _R (V DC)	450	575	800	900	1100	1300
C _R (µF)						
14						
20						
25						
27						
30						
35						
38						
40						
42						
45						
50						
55						
58						
60						
70						
75						
80						
90						
100						
110						
120						
130						
150						
170						
180						
200						
210						
270						
360						
480						



B32774

MKP DC link - high density series up to 480 µF

Ordering codes and packing units (lead spacing 27.5 mm)



							•	•
$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	$\tan\delta$	$\tan\delta$	Un-
	wxhxl	(composition see	70 °C	70 °C				taped
		below)	10 kHz	10 kHz		1 kHz	10 kHz	pcs./
μF	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,70 \text{ °C}} = 450 \text{ V DC}, V_{op,85 \text{ °C}} = 450 \text{ V DC}$								
5.0	11.0 x 21.0 x 31.5	B32774D4505+000	5.0	21.1	19.0	1.2	10.7	2352
10.0	15.0 x 24.5 x 31.5	B32774D4106+000	8.0	10.9	24.0	1.2	11.0	1680
22.0	22.0 x 36.5 x 31.5	B32774D4226+000	14.5	5.4	30.0	1.3	12.1	784
$V_{R,70}$	$_{^{\circ}C}$ = 800 V DC, V_{op}	_{,85 °C} = 700 V DC						
3.0	11.0 x 21.0 x 31.5	B32774D8305+000	4.5	24.8	19.0	0.9	7.6	2352
5.0	14.0 x 24.5 x 31.5	B32774D8505+000	6.5	15.3	23.0	0.9	7.7	1848
12.0	22.0 x 36.5 x 31.5	B32774D8126+000	13.0	6.8	34.0	1.0	8.3	784
$V_{R,70}$	_{°C} = 1100 V DC, V _o	_{p,85 °C} = 920 V DC						
2.0	12.5 x 21.5 x 31.5	B32774D0205+000	4.5	26.3	19.0	0.7	5.3	2100
3.3	18.0 x 27.5 x 31.5	B32774D0335+000	7.0	16.2	22.0	0.7	5.4	1428
5.0	19.0 x 30.0 x 31.5	B32774D0505+000	9.0	10.9	27.0	0.7	5.5	896
7.0	22.0 x 36.5 x 31.5	B32774D0705+000	12.0	8.1	30.0	0.7	5.8	784
$V_{R,70}$	$_{^{\circ}C}$ = 1300 V DC, V_{c}	_{op,85 °C} = 1100 V DC						
1.5	12.5 x 21.5 x 31.5	B32774D1155K000	4.4	31.3	20.0	0.6	4.8	2100
3.0	18.0 x 27.5 x 31.5	B32774D1305K000	7.0	16.0	24.0	0.6	4.9	1428
5.0	22.0 x 36.5 x 31.5	B32774D1505K000	10.5	9.8	33.0	0.7	5.1	784

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 -1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for ΔT ≤20 °C at ΔESR_{typ} ≤±5%
 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)



B32776

MKP DC link - high density series up to 480 µF

Ordering codes and packing units (lead spacing 37.5 mm)



$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$										37.5
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	C _R 1)	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} 3)	$tan \ \delta$	tan δ	Un-
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		wxhxl		(composition see	70 °C	70 °C				taped
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				below)	10 kHz	10 kHz				pcs./
12	μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	V _{R,70}	_{0 °C} = 450 V DC, V _{op,}	_{85 °C} =	450 V DC						
30 20.0 x 39.5 x 42.0 10.2 B32776G4306+000 14.0 7.0 11.0 2.3 21.3 640 30 20.0 x 39.5 x 42.0 — B32776E4306+000 14.0 7.3 28.0 2.4 22.3 640 35 28.0 x 37.0 x 42.0 10.2 B32776G4356+000 16.5 6.0 10.0 2.3 21.4 440 40 28.0 x 37.0 x 42.0 — B32776G4406+000 17.5 5.3 11.0 2.3 21.4 440 40 28.0 x 37.0 x 42.0 — B32776E4406+000 17.0 5.6 26.0 2.4 22.7 440 40 43.0 x 22.0 x 41.5 20.3 B32776E4406+000 17.0 5.6 26.0 2.4 22.7 440 50 28.0 x 42.5 x 42.0 10.2 B32776E4506+000 20.0 4.3 12.0 2.3 21.7 440 60 30.0 x 45.0 x 42.0 20.3 B32776E4606+000 23.5 3.6 14.0 2.4 22.3 400 65 33.0 x 48.0 x 42.0 — B32776E4606+000 25.5	12	24.0 x 15.0 x 41.5	_	B32776T4126K000	7.0	17.1	19.0	2.2	21.0	1040
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	16	24.0 x 19.0 x 41.5	_	B32776T4166K000	8.0	13.0	18.0	2.3	21.2	780
35 28.0 x 37.0 x 42.0 10.2 B32776G4356+000 16.5 6.0 10.0 2.3 21.4 440 35 28.0 x 37.0 x 42.0 - B32776E4356+000 16.0 6.4 24.0 2.4 22.6 440 40 28.0 x 37.0 x 42.0 10.2 B32776G4406+000 17.5 5.3 11.0 2.3 21.4 440 40 28.0 x 37.0 x 42.0 - B32776E4406+000 17.0 5.6 26.0 2.4 22.7 440 40 43.0 x 22.0 x 41.5 20.3 B32776G4506+000 17.0 5.2 13.0 2.3 21.2 280 50 28.0 x 42.5 x 42.0 10.2 B32776E4506+000 20.0 4.3 12.0 2.3 21.7 440 60 30.0 x 45.0 x 42.0 20.3 B32776E4506+000 23.5 3.6 14.0 2.4 22.3 400 65 33.0 x 48.0 x 42.0 20.3 B32776E4606+000 22.0 4.0 32.0 2.5 24.2 400 65 24.0 x 15.0 x 41.5 - B32776E5856+000 25.5	30	20.0 x 39.5 x 42.0	10.2	B32776G4306+000	14.0	7.0	11.0	2.3	21.3	640
35 28.0 x 37.0 x 42.0 - B32776E4356+000 16.0 6.4 24.0 2.4 22.6 440 40 28.0 x 37.0 x 42.0 10.2 B32776G4406+000 17.5 5.3 11.0 2.3 21.4 440 40 28.0 x 37.0 x 42.0 - B32776E4406+000 17.0 5.6 26.0 2.4 22.7 440 40 43.0 x 22.0 x 41.5 20.3 B32776G4506+000 17.0 5.2 13.0 2.3 21.2 280 50 28.0 x 42.5 x 42.0 10.2 B32776E4506+000 20.0 4.3 12.0 2.3 21.7 440 60 30.0 x 45.0 x 42.0 20.3 B32776E4506+000 19.0 4.7 30.0 2.5 23.8 440 60 30.0 x 45.0 x 42.0 20.3 B32776E4606+000 22.0 4.0 32.0 2.5 24.2 400 65 33.0 x 48.0 x 42.0 20.3 B32776E4606+000 25.5 3.3 14.0 2.3 22.2 180 VR.70 °C = 575 V DC, V _{op.85} °C = 500 V DC 8.5 24.0 x 15.0 x 41.5 <	30	20.0 x 39.5 x 42.0	_	B32776E4306+000	14.0	7.3	28.0	2.4	22.3	640
40 28.0 x 37.0 x 42.0 10.2 B32776G4406+000 17.5 5.3 11.0 2.3 21.4 440 40 28.0 x 37.0 x 42.0 — B32776E4406+000 17.0 5.6 26.0 2.4 22.7 440 40 43.0 x 22.0 x 41.5 20.3 B32776T4406K000 17.0 5.2 13.0 2.3 21.2 280 50 28.0 x 42.5 x 42.0 10.2 B32776G4506+000 20.0 4.3 12.0 2.3 21.7 440 60 30.0 x 45.0 x 42.0 — B32776G4606+000 23.5 3.6 14.0 2.4 22.3 400 60 30.0 x 45.0 x 42.0 — B32776G4656+000 25.5 3.3 14.0 2.4 22.3 400 65 33.0 x 48.0 x 42.0 20.3 B32776G4656+000 25.5 3.3 14.0 2.3 22.2 180 VR,70 °C = 575 V DC, Vop.85 °C = 500 V DC 8.5 24.0 x 15.0 x 41.5 — B32776T5855+000 6.5 19.9 19.0 1.9 17.4 780 25 20.0 x 39.5 x 42.0 10.2<	35	28.0 x 37.0 x 42.0	10.2	B32776G4356+000	16.5	6.0	10.0	2.3	21.4	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	35	28.0 x 37.0 x 42.0	_	B32776E4356+000	16.0	6.4	24.0	2.4	22.6	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	40	28.0 x 37.0 x 42.0	10.2	B32776G4406+000	17.5	5.3	11.0	2.3	21.4	440
50 28.0 x 42.5 x 42.0 10.2 B32776G4506+000 20.0 4.3 12.0 2.3 21.7 440 50 28.0 x 42.5 x 42.0 - B32776E4506+000 19.0 4.7 30.0 2.5 23.8 440 60 30.0 x 45.0 x 42.0 - B32776E4606+000 23.5 3.6 14.0 2.4 22.3 400 60 30.0 x 45.0 x 42.0 - B32776E4606+000 22.0 4.0 32.0 2.5 24.2 400 65 33.0 x 48.0 x 42.0 20.3 B32776G4656+000 25.5 3.3 14.0 2.3 22.2 180 V _{R,70} °C = 575 V DC, V _{op,85} °C = 500 V DC 8.5 24.0 x 15.0 x 41.5 - B32776T5855+000 6.5 19.9 19.0 1.9 17.2 1040 12 24.0 x 19.0 x 41.5 - B32776G55256K000 14.0 7.0 12.0 1.9 17.5 640 25 20.0 x 39.5 x 42.0 10.2 B32776E5256K000 13.5	40	28.0 x 37.0 x 42.0	_	B32776E4406+000	17.0	5.6	26.0	2.4	22.7	440
50 28.0 x 42.5 x 42.0 - B32776E4506+000 19.0 4.7 30.0 2.5 23.8 440 60 30.0 x 45.0 x 42.0 20.3 B32776E4606+000 23.5 3.6 14.0 2.4 22.3 400 60 30.0 x 45.0 x 42.0 - B32776E4606+000 22.0 4.0 32.0 2.5 24.2 400 65 33.0 x 48.0 x 42.0 20.3 B32776G4656+000 25.5 3.3 14.0 2.3 22.2 180 V _{R,70 °C} = 575 V DC, V _{op,85 °C} = 500 V DC 8.5 24.0 x 15.0 x 41.5 - B32776T5855+000 6.5 19.9 19.0 1.9 17.2 1040 12 24.0 x 19.0 x 41.5 - B32776T5126K000 8.0 14.4 18.0 1.9 17.4 780 25 20.0 x 39.5 x 42.0 10.2 B32776E5256K000 14.0 7.0 12.0 1.9 17.5 640 27 43.0 x 22.0 x 41.5 20.3 B32776E5256K000 15.5	40	43.0 x 22.0 x 41.5	20.3	B32776T4406K000	17.0	5.2	13.0	2.3	21.2	280
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	50	28.0 x 42.5 x 42.0	10.2	B32776G4506+000	20.0	4.3	12.0	2.3	21.7	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	50	28.0 x 42.5 x 42.0	_	B32776E4506+000	19.0	4.7	30.0	2.5	23.8	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	60	30.0 x 45.0 x 42.0	20.3	B32776G4606+000	23.5	3.6	14.0	2.4	22.3	400
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	60	30.0 x 45.0 x 42.0	_	B32776E4606+000	22.0	4.0	32.0	2.5	24.2	400
8.5 24.0 x 15.0 x 41.5 - B32776T5855+000 6.5 19.9 19.0 1.9 17.2 1040 12 24.0 x 19.0 x 41.5 - B32776T5126K000 8.0 14.4 18.0 1.9 17.4 780 25 20.0 x 39.5 x 42.0 10.2 B32776E5256K000 14.0 7.0 12.0 1.9 17.5 640 25 20.0 x 39.5 x 42.0 - B32776E5256K000 13.5 7.4 28.0 2.0 18.3 640 27 43.0 x 22.0 x 41.5 20.3 B32776T5276K000 15.5 6.4 14.0 1.9 17.5 280 30 28.0 x 37.0 x 42.0 10.2 B32776E5306K000 16.5 5.8 11.0 1.9 17.6 440 35 28.0 x 42.5 x 42.0 10.2 B32776E5306K000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0	65	33.0 x 48.0 x 42.0	20.3	B32776G4656+000	25.5	3.3	14.0	2.3	22.2	180
12 24.0 x 19.0 x 41.5 — B32776T5126K000 8.0 14.4 18.0 1.9 17.4 780 25 20.0 x 39.5 x 42.0 10.2 B32776G5256K000 14.0 7.0 12.0 1.9 17.5 640 25 20.0 x 39.5 x 42.0 — B32776E5256K000 13.5 7.4 28.0 2.0 18.3 640 27 43.0 x 22.0 x 41.5 20.3 B32776T5276K000 15.5 6.4 14.0 1.9 17.5 280 30 28.0 x 37.0 x 42.0 10.2 B32776G5306K000 16.5 5.8 11.0 1.9 17.6 440 35 28.0 x 42.5 x 42.0 10.2 B32776G5356+000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 — B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 — B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 — B32776E5456K000 21.0	V _{R,70}	_{0°C} = 575 V DC, V _{op,}	_{85 °C} =	500 V DC						
25 20.0 x 39.5 x 42.0 10.2 B32776G5256K000 14.0 7.0 12.0 1.9 17.5 640 25 20.0 x 39.5 x 42.0 - B32776E5256K000 13.5 7.4 28.0 2.0 18.3 640 27 43.0 x 22.0 x 41.5 20.3 B32776T5276K000 15.5 6.4 14.0 1.9 17.5 280 30 28.0 x 37.0 x 42.0 10.2 B32776E5306K000 16.5 5.8 11.0 1.9 17.6 440 35 28.0 x 42.5 x 42.0 - B32776E53366K000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 20.3 B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	8.5	24.0 x 15.0 x 41.5	_	B32776T5855+000	6.5	19.9	19.0	1.9	17.2	1040
25 20.0 x 39.5 x 42.0 - B32776E5256K000 13.5 7.4 28.0 2.0 18.3 640 27 43.0 x 22.0 x 41.5 20.3 B32776T5276K000 15.5 6.4 14.0 1.9 17.5 280 30 28.0 x 37.0 x 42.0 10.2 B32776G5306K000 16.5 5.8 11.0 1.9 17.6 440 35 28.0 x 42.5 x 42.0 10.2 B32776G5356+000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 20.3 B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	12	24.0 x 19.0 x 41.5	_	B32776T5126K000	8.0	14.4	18.0	1.9	17.4	780
27 43.0 x 22.0 x 41.5 20.3 B32776T5276K000 15.5 6.4 14.0 1.9 17.5 280 30 28.0 x 37.0 x 42.0 10.2 B32776G5306K000 16.5 5.8 11.0 1.9 17.6 440 30 28.0 x 37.0 x 42.0 - B32776E5306K000 16.5 6.1 26.0 2.0 18.5 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 19.0 5.0 12.0 1.9 17.8 440 45 30.0 x 45.0 x 42.0 20.3 B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	25	20.0 x 39.5 x 42.0	10.2	B32776G5256K000	14.0	7.0	12.0	1.9	17.5	640
30 28.0 x 37.0 x 42.0 10.2 B32776G5306K000 16.5 5.8 11.0 1.9 17.6 440 30 28.0 x 37.0 x 42.0 - B32776E5306K000 16.5 6.1 26.0 2.0 18.5 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 19.0 5.0 12.0 1.9 17.8 440 45 30.0 x 45.0 x 42.0 20.3 B32776G5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	25	20.0 x 39.5 x 42.0	_	B32776E5256K000	13.5	7.4	28.0	2.0	18.3	640
30 28.0 x 37.0 x 42.0 - B32776E5306K000 16.5 6.1 26.0 2.0 18.5 440 35 28.0 x 42.5 x 42.0 10.2 B32776G5356+000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 20.3 B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	27	43.0 x 22.0 x 41.5	20.3	B32776T5276K000	15.5	6.4	14.0	1.9	17.5	280
35 28.0 x 42.5 x 42.0 10.2 B32776G5356+000 19.0 5.0 12.0 1.9 17.8 440 35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 - B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	30	28.0 x 37.0 x 42.0	10.2	B32776G5306K000	16.5	5.8	11.0	1.9	17.6	440
35 28.0 x 42.5 x 42.0 - B32776E5356+000 18.0 5.3 29.0 2.0 19.0 440 45 30.0 x 45.0 x 42.0 - B32776E5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	30	28.0 x 37.0 x 42.0	_	B32776E5306K000	16.5	6.1	26.0	2.0	18.5	440
45 30.0 x 45.0 x 42.0 20.3 B32776G5456K000 22.0 4.0 13.0 1.9 17.9 400 45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	35	28.0 x 42.5 x 42.0	10.2	B32776G5356+000	19.0	5.0	12.0	1.9	17.8	440
45 30.0 x 45.0 x 42.0 - B32776E5456K000 21.0 4.4 32.0 2.1 19.7 400	35	28.0 x 42.5 x 42.0	_	B32776E5356+000	18.0	5.3	29.0	2.0	19.0	440
	45	30.0 x 45.0 x 42.0	20.3	B32776G5456K000	22.0	4.0	13.0	1.9	17.9	400
50 33.0 x 48.0 x 42.0 20.3 B32776G5506K000 25.0 3.5 14.0 2.0 18.1 180	45	30.0 x 45.0 x 42.0	_	B32776E5456K000	21.0	4.4	32.0	2.1	19.7	400
	50	33.0 x 48.0 x 42.0	20.3	B32776G5506K000	25.0	3.5	14.0	2.0	18.1	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 -1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for ΔT ≤20 °C at ΔESR_{typ} ≤±5%
 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)



MKP DC link - high density series up to 480 µF

Ordering codes and packing units (lead spacing 37.5 mm)



$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$									→ (37.5 ▮◀
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	$C_R^{1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{tvp}	ESL _{typ} 3)	$tan \ \delta$	tan δ	Un-
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		wxhxl		(composition see	70 °Ć		, ,			taped
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				below)	10 kHz	10 kHz				pcs./
6.8 24.0 x 15.0 x 41.5 — B32776T8685+000 6.0 22.1 18.0 1.7 15.1 1040 8.5 24.0 x 19.0 x 41.5 — B32776T8855+000 7.5 17.8 18.0 1.7 15.1 780 14 18.0 x 32.5 x 41.5 — B32776E8146+000 10.0 11.5 23.0 1.8 16.3 720 15 20.0 x 39.5 x 42.0 10.2 B32776E8156+000 12.0 9.6 10.0 1.7 15.2 640 15 20.0 x 39.5 x 42.0 — B32776E8156+000 11.5 10.3 24.0 1.7 15.7 640 20 28.0 x 37.0 x 42.0 — B32776E8266+000 14.5 7.5 10.0 1.7 15.3 440 20 28.0 x 37.0 x 42.0 — B32776E8266+000 14.5 7.8 24.0 1.7 15.1 280 22 28.0 x 37.0 x 42.0 10.2 B32776E8266+000 15.5 6.8 11.0 1.7 15.1 24.0	μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
8.5 24.0 x 19.0 x 41.5 -	$V_{R,70}$	°C = 800 V DC, V _{op,}	_{85 °C} =	700 V DC						
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	6.8	24.0 x 15.0 x 41.5	_	B32776T8685+000	6.0	22.1	18.0	1.7	15.1	1040
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	8.5	24.0 x 19.0 x 41.5	_	B32776T8855+000	7.5	17.8	18.0	1.7	15.1	780
15 20.0 x 39.5 x 42.0 — B32776E8156+000 11.5 10.3 24.0 1.7 15.7 640 20 28.0 x 37.0 x 42.0 10.2 B32776G8206+000 14.5 7.5 10.0 1.7 15.3 440 20 28.0 x 37.0 x 42.0 — B32776T8206K000* 14.5 7.8 24.0 1.7 15.9 440 20 28.0 x 37.0 x 42.0 10.2 B32776G8226+000 15.5 6.8 11.0 1.7 15.3 440 22 28.0 x 37.0 x 42.0 — B32776E8226+000 15.5 6.8 11.0 1.7 15.3 440 25 28.0 x 42.5 x 42.0 10.2 B32776G8256+000 17.0 6.1 11.0 1.7 15.4 440 25 28.0 x 42.5 x 42.0 — B32776E8256+000 16.5 6.4 28.0 1.8 16.3 440 30 30.0 x 45.0 x 42.0 — B32776E8366+000 19.5 5.1 12.0 1.7 15.6 400 35 33.0 x 48.0 x 42.0 20.3 B32776T89505+000 5.5	14	18.0 x 32.5 x 41.5	_	B32776E8146+000	10.0	11.5	23.0	1.8	16.3	720
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	15	20.0 x 39.5 x 42.0	10.2	B32776G8156+000	12.0	9.6	10.0	1.7	15.2	640
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	15		_	B32776E8156+000	11.5	10.3	24.0	1.7	15.7	640
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	20	28.0 x 37.0 x 42.0	10.2	B32776G8206+000	14.5	7.5	10.0	1.7	15.3	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	20	28.0 x 37.0 x 42.0	_	B32776E8206+000	14.5	7.8	24.0	1.7	15.9	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	20	43.0 x 22.0 x 41.5	20.3	B32776T8206K000*	14.5	7.2	9.0	1.7	15.1	280
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	22	28.0 x 37.0 x 42.0	10.2	B32776G8226+000	15.5	6.8	11.0	1.7	15.3	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	22	28.0 x 37.0 x 42.0	_	B32776E8226+000	15.0	7.1	25.0	1.7	16.0	440
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	25	28.0 x 42.5 x 42.0	10.2	B32776G8256+000	17.0	6.1	11.0	1.7	15.4	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	25	28.0 x 42.5 x 42.0	_	B32776E8256+000	16.5	6.4	28.0	1.8	16.3	440
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	30	30.0 x 45.0 x 42.0	20.3	B32776G8306+000	19.5	5.1	12.0	1.7	15.6	400
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	30	30.0 x 45.0 x 42.0	_	B32776E8306+000	19.0	5.5	30.0	1.8	16.7	400
5 24.0 x 15.0 x 41.5 - B32776T9505+000 5.5 26.1 19.0 1.5 13.4 1040 7.5 24.0 x 19.0 x 41.5 - B32776T9755K000 7.5 17.8 18.0 1.5 13.5 780 15 20.0 x 39.5 x 42.0 10.2 B32776G9156K000 12.5 9.1 12.0 1.5 13.6 640 15 20.0 x 39.5 x 42.0 - B32776E9156K000 12.0 9.4 28.0 1.5 14.1 640 16 43.0 x 22.0 x 41.5 20.3 B32776T9166K000* 14.0 8.1 9.0 1.5 13.5 280 20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 44	35	33.0 x 48.0 x 42.0	20.3	B32776G8356+000	22.0	4.3	14.0	1.7	15.7	180
7.5 24.0 x 19.0 x 41.5 - B32776T9755K000 7.5 17.8 18.0 1.5 13.5 780 15 20.0 x 39.5 x 42.0 10.2 B32776G9156K000 12.5 9.1 12.0 1.5 13.6 640 15 20.0 x 39.5 x 42.0 - B32776E9156K000 12.0 9.4 28.0 1.5 14.1 640 16 43.0 x 22.0 x 41.5 20.3 B32776T9166K000* 14.0 8.1 9.0 1.5 13.5 280 20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440	$V_{R,70}$	$_{0 \text{ °C}}$ = 900 V DC, $V_{op,3}$	₈₅ °C =	800 V DC						
15 20.0 x 39.5 x 42.0 10.2 B32776G9156K000 12.5 9.1 12.0 1.5 13.6 640 15 20.0 x 39.5 x 42.0 - B32776E9156K000 12.0 9.4 28.0 1.5 14.1 640 16 43.0 x 22.0 x 41.5 20.3 B32776T9166K000* 14.0 8.1 9.0 1.5 13.5 280 20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440	5		_	B32776T9505+000	5.5	26.1		1.5	13.4	1040
15 20.0 x 39.5 x 42.0 - B32776E9156K000 12.0 9.4 28.0 1.5 14.1 640 16 43.0 x 22.0 x 41.5 20.3 B32776T9166K000* 14.0 8.1 9.0 1.5 13.5 280 20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440	7.5	24.0 x 19.0 x 41.5	_	B32776T9755K000	7.5	17.8	18.0	1.5	13.5	780
16 43.0 x 22.0 x 41.5 20.3 B32776T9166K000* 14.0 8.1 9.0 1.5 13.5 280 20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440		20.0 x 39.5 x 42.0	10.2	B32776G9156K000		9.1		1.5	13.6	640
20 28.0 x 37.0 x 42.0 10.2 B32776G9206K000 15.0 7.0 11.0 1.5 13.6 440 20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440		20.0 x 39.5 x 42.0	_	B32776E9156K000		9.4	28.0	1.5	14.1	640
20 28.0 x 37.0 x 42.0 - B32776E9206K000 15.0 7.3 26.0 1.6 14.2 440 22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440		43.0 x 22.0 x 41.5	20.3	B32776T9166K000*		8.1	9.0	1.5		280
22 28.0 x 42.5 x 42.0 10.2 B32776G9226K000 17.0 6.3 12.0 1.5 13.7 440	20	28.0 x 37.0 x 42.0	10.2	B32776G9206K000		7.0	11.0	1.5	13.6	440
	20	28.0 x 37.0 x 42.0	_	B32776E9206K000	15.0	7.3	26.0	1.6	14.2	440
22 20 0 × 42 5 × 42 0	22	28.0 x 42.5 x 42.0	10.2	B32776G9226K000	17.0	6.3	12.0	1.5	13.7	440
22 26.0 x 42.5 x 42.0 - B32776E9226K000 16.5 6.6 29.0 1.0 14.5 440	22	28.0 x 42.5 x 42.0	_	B32776E9226K000	16.5	6.6	29.0	1.6	14.5	440
25 30.0 x 45.0 x 42.0 20.3 B32776G9256+000 19.0 5.5 13.0 1.5 13.8 400	25	30.0 x 45.0 x 42.0	20.3	B32776G9256+000	19.0	5.5	13.0	1.5	13.8	400
25 30.0 x 45.0 x 42.0 - B32776E9256+000 18.5 5.9 32.0 1.6 14.7 400	25	30.0 x 45.0 x 42.0	_	B32776E9256+000		5.9	32.0	1.6	14.7	400
30 33.0 x 48.0 x 42.0 20.3 B32776G9306+000 21.5 4.7 14.0 1.5 13.9 180	30	33.0 x 48.0 x 42.0	20.3	B32776G9306+000	21.5	4.7	14.0	1.5	13.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 –1 mm)

2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$

¹⁾ Capacitance value measured at 1 kHz

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

This part is affected by "Dual Use" regulations according to the law of the country the production site is located in. Deliveries of such products are subject to prior approval of the respective local authorities based on customer declarations. The delivery to certain countries may be restricted.



B32776

MKP DC link – high density series up to 480 μF

Ordering codes and packing units (lead spacing 37.5 mm)



								—	37.5
$C_R^{1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	$tan \ \delta$	tan δ	Un-
	wxhxl		(composition see	70 °Ć	70 °C	,,,			taped
			below)	10 kHz	10 kHz				pcs./
μF	mm	mm		Α	mΩ	nΗ	10 ⁻³	10 ⁻³	MOQ
$V_{R,70}$	_{0 °C} = 1100 V DC, V _{op}	,85 °C =	920 V DC						
3.9	24.0 x 15.0 x 41.5	_	B32776T0395+000	5.0	30.5	18.0	1.4	12.1	1040
5	24.0 x 19.0 x 41.5	_	B32776T0505+000	6.5	23.6	18.0	1.4	12.1	780
12	20.0 x 39.5 x 42.0	10.2	B32776G0126+000	12.0	10.2	12.0	1.4	12.2	640
12	20.0 x 39.5 x 42.0	_	B32776E0126+000	11.5	10.5	28.0	1.4	12.6	640
13	43.0 x 22.0 x 41.5	20.3	B32776T0136K000*	13.0	8.9	9.0	1.4	12.1	280
14	28.0 x 37.0 x 42.0	10.2	B32776G0146+000	13.5	8.7	21.0	1.4	12.2	440
14	28.0 x 37.0 x 42.0	_	B32776E0146+000	13.5	9.0	25.0	1.4	12.6	440
16	28.0 x 42.5 x 42.0	10.2	B32776G0166+000	15.5	7.4	12.0	1.4	12.3	440
16	28.0 x 42.5 x 42.0	_	B32776E0166+000	15.0	7.8	30.0	1.4	12.9	440
20	30.0 x 45.0 x 42.0	20.3	B32776G0206+000	18.0	6.0	14.0	1.4	12.4	400
20	30.0 x 45.0 x 42.0	_	B32776E0206+000	17.5	6.5	32.0	1.4	13.1	400
22	33.0 x 48.0 x 42.0	20.3	B32776G0226+000	21.0	4.9	15.0	1.3	11.4	180
$V_{R,70}$	$_{0 \text{ °C}}$ = 1300 V DC, V_{op}	,85 °C =	= 1100 V DC						
2.7	24.0 x 15.0 x 41.5	_	B32776T1275+000	5.0	34.7	19.0	1.1	9.6	1040
3.5	24.0 x 19.0 x 41.5	_	B32776T1355+000	6.0	27.4	18.0	1.1	9.7	780
8.0	20.0 x 39.5 x 42.0	10.2	B32776G1805+000	11.0	12.1	12.0	1.1	9.7	640
8.0	20.0 x 39.5 x 42.0	_	B32776E1805+000	10.5	12.4	24.0	1.2	10.0	640
9.0	43.0 x 22.0 x 41.5	20.3	B32776T1905K000*	12.0	10.7	9.0	1.1	9.7	280
10	28.0 x 37.0 x 42.0	10.2	B32776G1106+000	13.0	9.6	11.0	1.1	9.7	440
10	28.0 x 37.0 x 42.0	_	B32776E1106+000	12.5	9.9	26.0	1.2	10.0	440
12	28.0 x 42.5 x 42.0	10.2	B32776G1126+000	14.5	8.1	12.0	1.1	9.8	440
12	28.0 x 42.5 x 42.0	_	B32776E1126+000	14.0	8.5	28.0	1.2	10.1	440
14	30.0 x 45.0 x 42.0	20.3	B32776G1146+000	17.0	6.8	14.0	1.1	10.1	400
14	30.0 x 45.0 x 42.0	_	B32776E1146+000	16.5	7.3	32.0	1.2	10.4	400
16	33.0 x 48.0 x 42.0	20.3	B32776G1166+000	19.0	6.0	15.0	1.1	9.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 –1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)
- * This part is affected by "Dual Use" regulations according to the law of the country the production site is located in. Deliveries of such products are subject to prior approval of the respective local authorities based on customer declarations. The delivery to certain countries may be restricted.

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B32778

MKP DC link – high density series up to 480 μ F

Ordering codes and packing units (lead spacing 52.5 mm, P_1 = 20.3 mm)



$\overline{C_R^{1)}}$	Max. dimensions	Ordering code	I _{RMS,max} 2)	ESR _{typ}	ESL _{typ} 3)	$\tan\delta$	tan δ	Un-
	wxhxl	(composition see	70 °C	70 °C	.,,,,			taped
		below)	10 kHz	10 kHz				pcs./
μF	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,70 \text{ °C}} = 450 \text{ V DC}, V_{op,85 \text{ °C}} = 450 \text{ V DC}$								
55	43.0 x 24.0 x 57.5	B32778T4556K000	16.5	7.2	13.0	4.3	41.7	560
75	30.0 x 45.0 x 57.5	B32778G4756+000	21.0	5.6	12.0	4.4	42.6	280
80	30.0 x 45.0 x 57.5	B32778G4806+000	21.5	5.3	13.0	4.4	42.7	280
100	35.0 x 50.0 x 57.5	B32778G4107+000	26.0	4.3	14.0	4.5	43.3	108
110	35.0 x 50.0 x 57.5	B32778G4117K000	27.0	3.9	15.0	4.5	43.6	108
150	130.0 x 24.0 x 57.5	B32778J4157K000	43.5	2.7	4.0	4.4	42.1	80
170	45.0 x 57.0 x 57.5	B32778G4177+000	36.5	2.6	17.0	4.6	45.7	140
180	60.0 x 45.0 x 57.5	B32778G4187+000	39.0	2.5	19.0	4.6	44.6	200
480	130.0 x 58.0 x 57.5	B32778J4487K000	79.5	0.9	6.0	4.8	45.4	40
$V_{R,7}$	$_{0 \text{ °C}}$ = 575 V DC, V_{op}	_{.85 °C} = 500 V DC						
40	43.0 x 24.0 x 57.5	B32778T5406K000	15.5	8.5	13.0	3.6	34.5	560
60	30.0 x 45.0 x 57.5	B32778G5606+000	20.5	5.8	13.0	3.7	35.3	280
80	35.0 x 50.0 x 57.5	B32778G5806+000	25.5	4.4	15.0	3.7	36.0	108
110	130.0 x 24.0 x 57.5	B32778J5117K000	40.5	3.0	5.0	3.6	34.5	80
120	45.0 x 57.0 x 57.5	B32778G5127+000	34.5	3.1	17.0	3.8	37.2	140
130	60.0 x 45.0 x 57.5	B32778G5137+000	36.5	2.8	19.0	3.8	36.7	200
360	130.0 x 58.0 x 57.5	B32778J5367K000	75.0	1.0	6.0	4.0	37.3	40

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 –1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le 20$ °C at $\Delta ESR_{typ} \le \pm 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)



B32778

MKP DC link - high density series up to 480 µF

Ordering codes and packing units (lead spacing 52.5 mm, P_1 = 20.3 mm)



							•	02.0	
$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} 3)	$tan \ \delta$	$tan \ \delta$	Un-	
	wxhxl	(composition see	70 °C	70 °C				taped	
		below)	10 kHz	10 kHz				pcs./	
μF	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ	
V _{R,70 °C} = 800 V DC, V _{op,85 °C} = 700 V DC									
30	43.0 x 24.0 x 57.5	B32778T8306K000*	14.5	9.8	9.0	3.2	30.2	560	
45	30.0 x 45.0 x 57.5	B32778G8456+000	19.5	6.6	14.0	3.2	30.9	280	
50	30.0 x 45.0 x 57.5	B32778G8506+000	20.0	6.3	13.0	3.2	30.9	280	
55	35.0 x 50.0 x 57.5	B32778G8556+000	23.0	5.6	14.0	3.2	31.1	108	
60	35.0 x 50.0 x 57.5	B32778G8606+000	23.5	5.1	15.0	3.3	31.2	108	
80	130.0 x 24.0 x 57.5	B32778J8806K000*	37.5	3.6	4.0	3.2	30.2	80	
90	45.0 x 57.0 x 57.5	B32778G8906+000	32.5	3.5	17.0	3.3	32.2	140	
100	60.0 x 45.0 x 57.5	B32778G8107+000	34.5	3.2	19.0	3.3	31.9	200	
270	130.0 x 58.0 x 57.5	B32778J8277K000*	70.5	1.2	6.0	3.5	32.4	40	
$V_{R,7}$	$V_{R,70 {}^{\circ}\text{C}} = 900 \text{V DC}, V_{op,85 {}^{\circ}\text{C}} = 800 \text{V DC}$								
25	43.0 x 24.0 x 57.5	B32778T9256K000*	13.5	10.7	9.0	2.8	26.8	560	
35	30.0 x 45.0 x 57.5	B32778G9356+000	18.0	7.7	13.0	2.9	27.3	280	
50	35.0 x 50.0 x 57.5	B32778G9506K000	22.5	5.6	15.0	2.9	27.7	108	
70	45.0 x 57.0 x 57.5	B32778G9706+000	31.0	3.8	18.0	3.0	28.5	140	
70	130.0 x 24.0 x 57.5	B32778J9706K000*	36.0	3.8	4.0	2.9	27.2	80	
75	60.0 x 45.0 x 57.5	B32778G9756+000	32.5	3.6	20.0	2.9	28.2	200	
210	130.0 x 58.0 x 57.5	B32778J9217K000*	66.0	1.3	6.0	3.1	28.6	40	

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 –1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for Δ T ≤20 °C at Δ ESR_{typ} ≤±5%
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)
- * This part is affected by "Dual Use" regulations according to the law of the country the production site is located in. Deliveries of such products are subject to prior approval of the respective local authorities based on customer declarations. The delivery to certain countries may be restricted.



B32778

MKP DC link - high density series up to 480 µF

Ordering codes and packing units (lead spacing 52.5 mm, P1 = 20.3 mm)



$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} 3)	$tan \ \delta$	tan δ	Un-		
	wxhxl	(composition see	70 °C	70 °C				taped		
		below)	10 kHz	10 kHz				pcs./		
μF	mm		Α	mΩ	nΗ	10 ⁻³	10 ⁻³	MOQ		
$V_{R,70}$	$V_{R,70 \text{ °C}}$ = 1100 V DC, $V_{op,85 \text{ °C}}$ = 920 V DC									
20	43.0 x 24.0 x 57.5	B32778T0206K000*	13.0	11.9	9.0	2.6	24.1	560		
30	30.0 x 45.0 x 57.5	B32778G0306+000	17.5	8.2	13.0	2.6	24.5	280		
40	35.0 x 50.0 x 57.5	B32778G0406+000	21.5	6.2	15.0	2.7	25.9	108		
58	45.0 x 57.0 x 57.5	B32778G0586+000	29.0	4.3	17.0	2.7	25.4	140		
60	60.0 x 45.0 x 57.5	B32778G0606+000	30.5	4.0	19.0	2.7	25.2	200		
60	130.0 x 24.0 x 57.5	B32778J0606K000*	34.5	4.1	4.0	2.7	25.1	80		
200	130.0 x 58.0 x 57.5	B32778J0207K000*	66.0	1.4	6.0	3.0	26.8	40		
V _{R,70}	V _{R,70 °C} = 1300 V DC, V _{op,85 °C} = 1100 V DC									
14	43.0 x 24.0 x 57.5	B32778T1146K000*	12.0	13.8	9.0	2.1	19.5	560		
20	30.0 x 45.0 x 57.5	B32778G1206+000	16.0	9.7	13.0	2.1	19.8	280		
25	35.0 x 50.0 x 57.5	B32778G1256+000	19.0	7.8	15.0	2.1	19.9	108		
27	35.0 x 50.0 x 57.5	B32778G1276+000	19.5	7.3	15.0	2.1	20.0	108		
38	130.0 x 24.0 x 57.5	B32778J1386K000*	31.5	5.1	4.0	2.1	19.5	80		
40	45.0 x 57.0 x 57.5	B32778G1406+000	26.5	5.0	17.0	2.2	20.3	140		
42	60.0 x 45.0 x 57.5	B32778G1426+000	28.0	4.7	19.0	2.2	20.2	200		
120	130.0 x 58.0 x 57.5	B32778J1127K000*	58.5	1.7	6.0	2.3	20.5	40		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$ Packing code:

 $K = \pm 10\%$ 000 = untaped (lead length 6 -1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for ∆T ≤20 °C at ∆ESR_{typ} ≤±5%
 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)
- This part is affected by "Dual Use" regulations according to the law of the country the production site is located in. Deliveries of such products are subject to prior approval of the respective local authorities based on customer declarations. The delivery to certain countries may be restricted.



Metallized polypropylene film capacitors (MKP)
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B32774 ... B32778

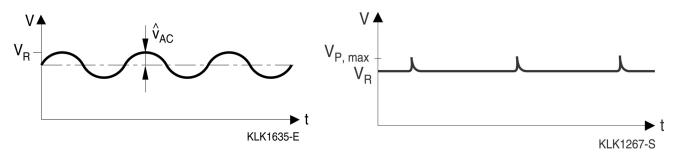
MKP DC link – high density series up to 480 μ F

Technical data

Reference standard: IEC 61071:2007. All data given at T = 20 °C, unless otherwise specified.

Operating temperate	Мах. ор	erating te	+105°	+105 °C				
			ategory t	emperatur	e T _{max}	+105 °	+105 °C	
		Lower c	ategory t	emperatur	e T _{min}	–40 °C		
Insulation resistance	e R _{ins}	τ > 10 0	00 s (afte	er 1 min)				
given as time consta	ant	For V _R 2	≥500 V m	neasured a	t 500 V			
$\tau = C_R \cdot R_{ins}$, rel. hu	umidity ≤ 65%	For V _R	<500 V m	neasured a	ıt V _R			
(minimum as-delive	red values)							
DC test voltage bety	1.5 · V _R							
Voltage test termina	2110 V AC, 50 Hz							
Pulse Handling Cap	I _P (A) / C (μF)							
Reliability:	10 fit (≤ 10 · 10 ⁻⁹ /h) at 0.5 · V _R , 40 °C							
- -	For conversion to other operating conditions and tem-							
	peratures, refer to chapter "Quality, 2 Reliability".							
	100 000 h at V _R and 70 °C							
V _R (V DC)		450	575	800	900	1100	1300	
Continuous operating voltage								
V _{op} (V DC) at 70 °C		450	575	800	900	1100	1300	
Continuous operating voltage								
V _{op} (V DC) at 85 °C	450	500	700	800	920	1100		
For temperatures be	1.33%/°C of V _{op} derating compared to V _{op} at 85 °C							
85 °C and 105 °C								

Typical waveforms



Restrictions:

V_R: Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.



B32774 ... B32778

MKP DC link - high density series up to 480 μF

Ŷ_{AC} ≤0.2 · V_R

Overvoltage	Maximum duration within one day	Observation
1.1 · V _R	30% of on-load duration	System regulation
1.15 · V _R	30 min	System regulation
1.2 · V _R	5 min	System regulation
1.3 · V _R	1 min	System regulation

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/µs.

Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Lead spacing	27.5 mm				37.5 mm					
Туре	B32774				B32776					
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
dV/dt in V/μs	30	40	75	100	21	22	22	35	54	73

Lead spacing	52.5 mm							
Туре	B32778							
V _R (V DC)	450	575	800	900	1100	1300		
dV/dt in V/μs	14	14	15	22	35	50		

MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

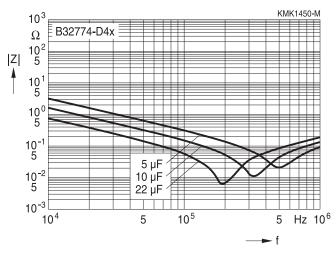


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

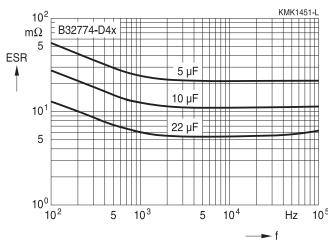


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

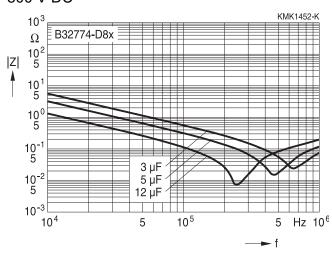


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

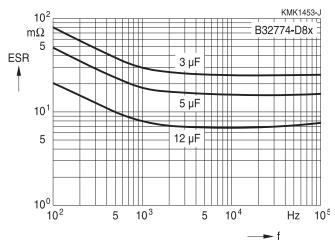
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

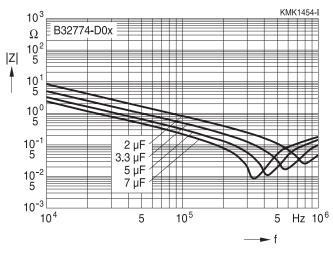


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

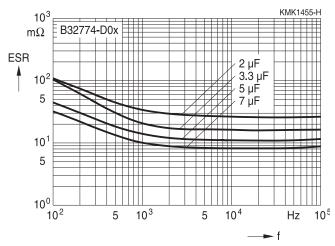


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

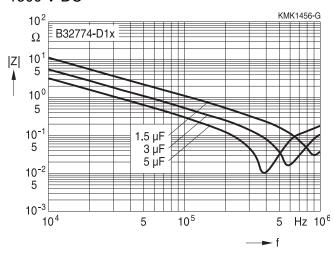


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

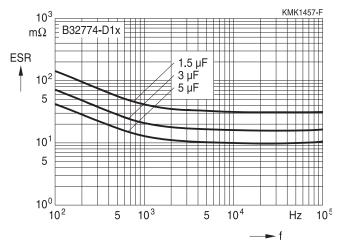
1300 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

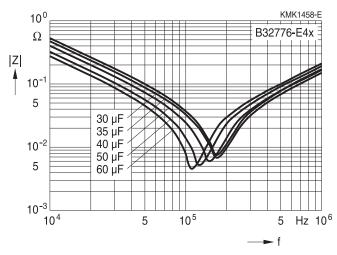


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

450 V DC

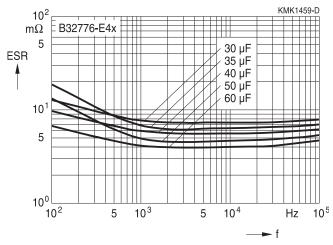


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

450 V DC

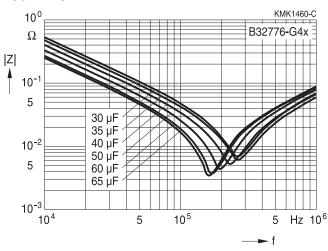


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

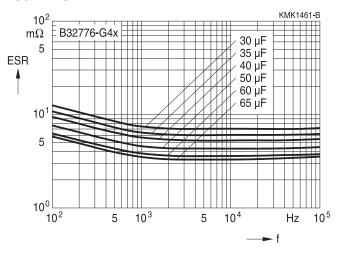
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

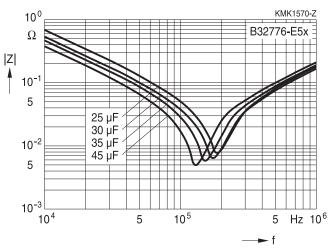


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

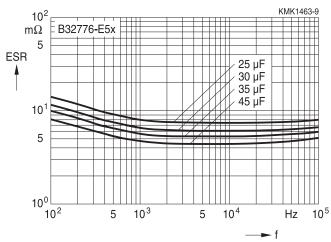


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

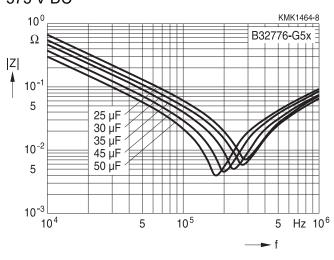


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

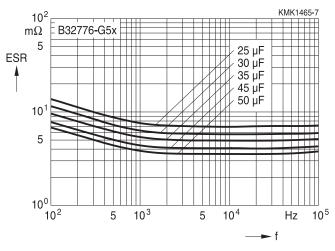
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

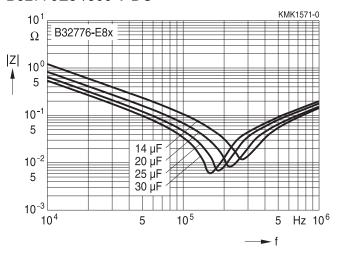


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

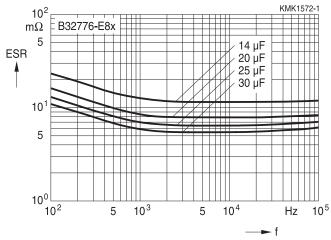


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

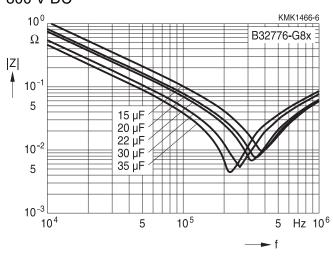


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

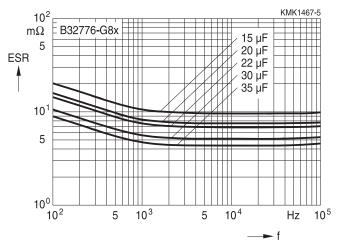
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 µF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

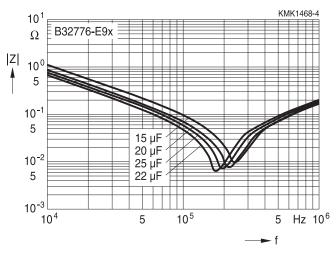


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

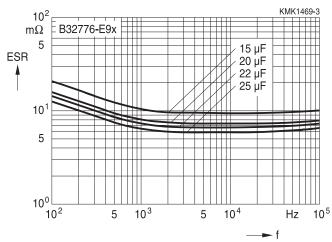


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

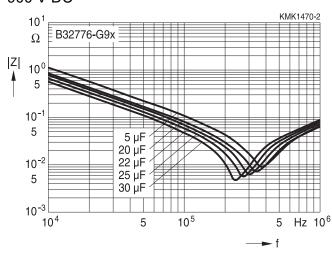


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

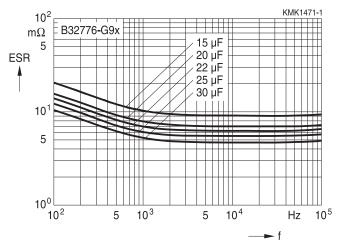
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

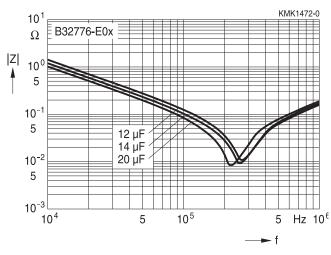


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

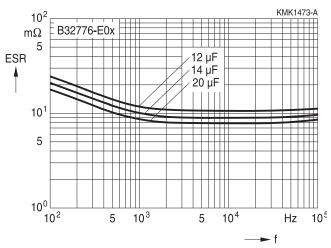


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

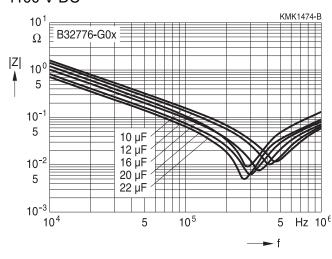


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

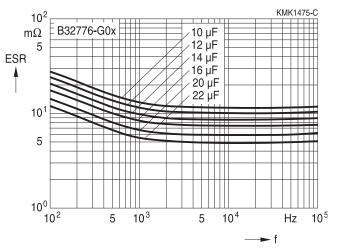
1100 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

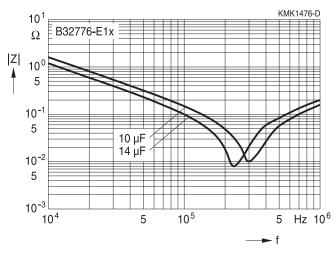


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

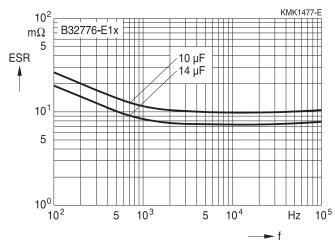


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

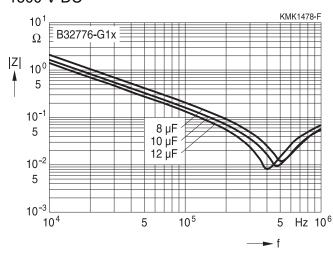


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

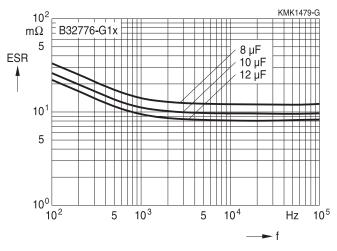
1300 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm



MKP DC link - high density series up to 480 μF

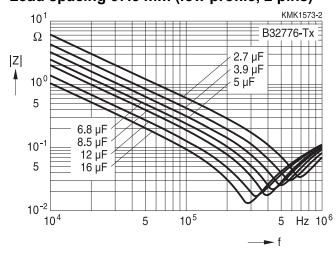
Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.



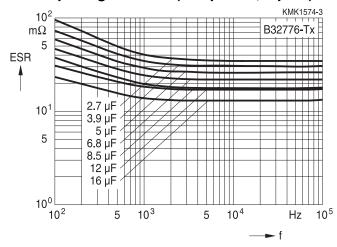
Impedance Z versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 2 pins)



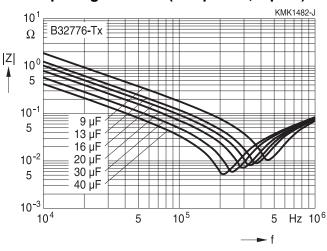
ESR versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 2 pins)



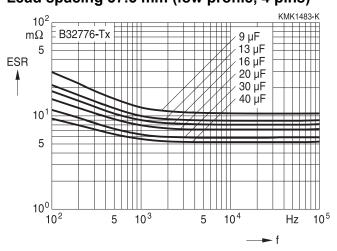
Impedance Z versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 4 pins)



ESR versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 4 pins)



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

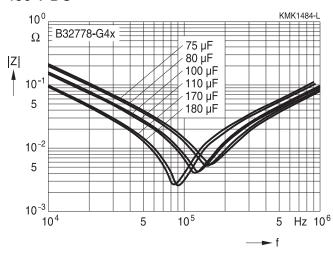


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

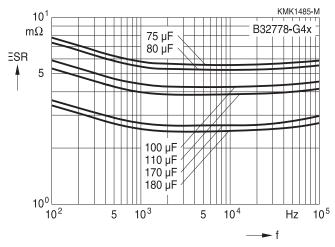


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

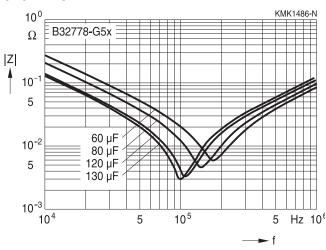


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

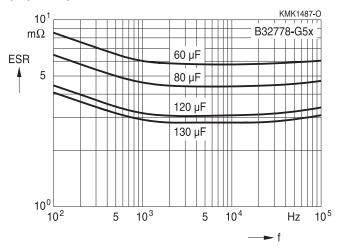
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

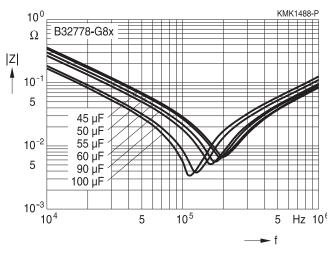


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

800 V DC

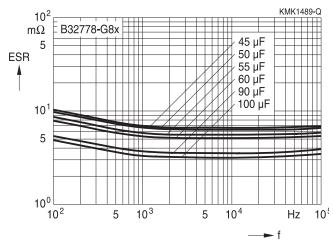


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

800 V DC

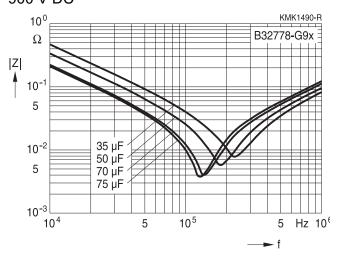


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

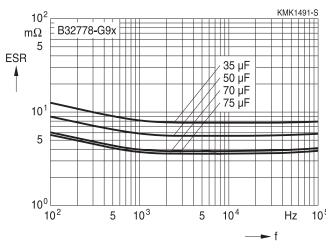
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm



MKP DC link - high density series up to 480 μF

Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.

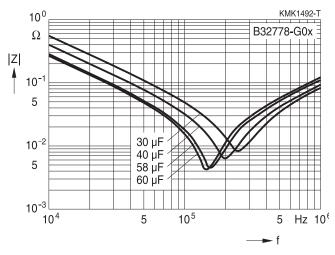


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

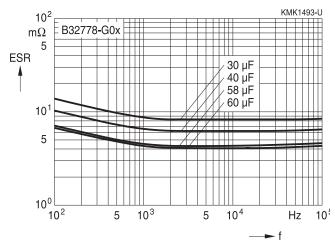


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

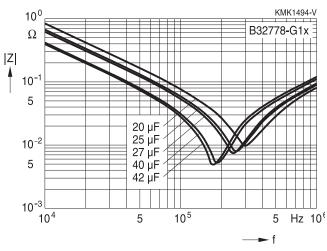


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

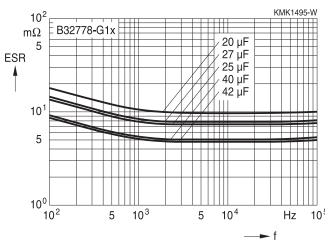
1300 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm



MKP DC link - high density series up to 480 µF

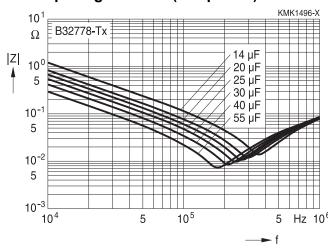
Characteristics curves

Additional technical information can be found under "Design support" on www.tdk-electronics.tdk.com.



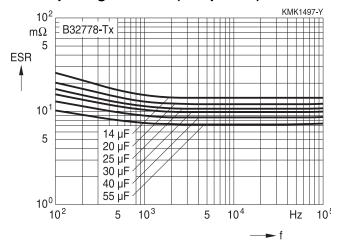
Impedance Z versus frequency f (typical values)

Lead spacing 52.5 mm (low profile)



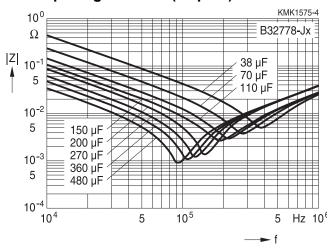
ESR versus frequency f (typical values)

Lead spacing 52.5 mm (low profile)



Impedance Z versus frequency f (typical values)

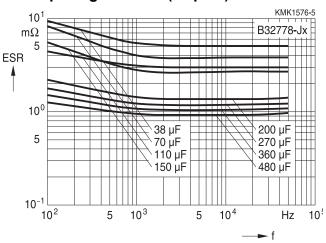
Lead spacing 52.5 mm (12 pins)



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm (12 pins)





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MKP DC link – high density series up to 480 μ F

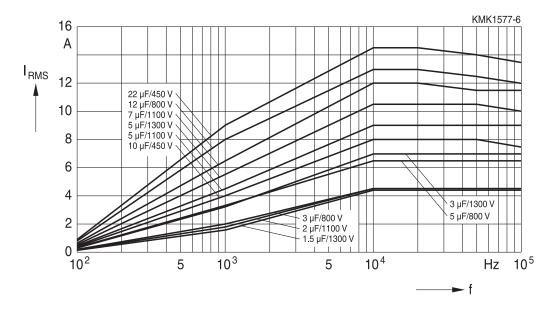
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C



Lead spacing 27.5 mm

B32774D*





B32776

MKP DC link - high density series up to 480 μF

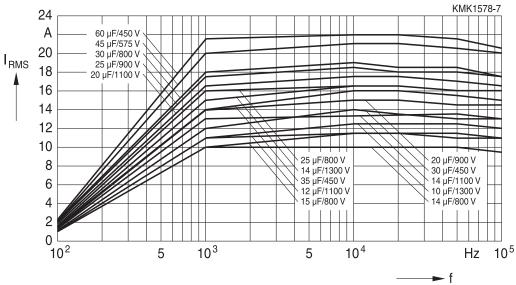
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

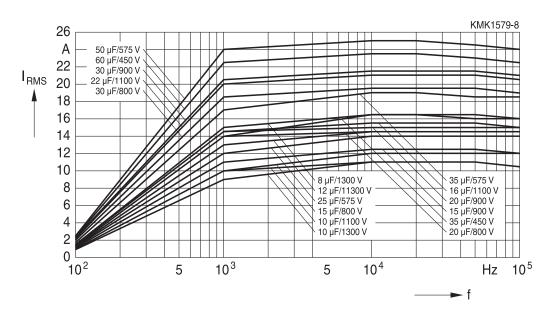


Lead spacing 37.5 mm

B32776E*



B32776G*





B32776

MKP DC link – high density series up to 480 μ F

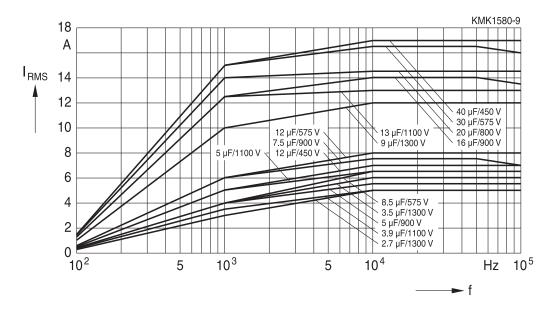
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C



Lead spacing 37.5 mm

B32776T*





B32778

MKP DC link - high density series up to 480 μF

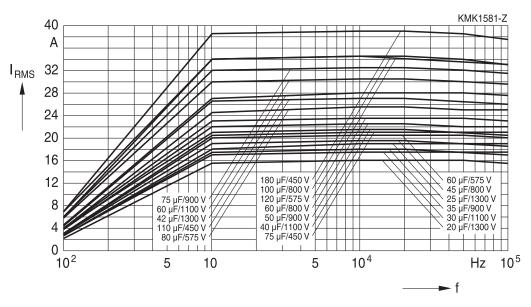
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

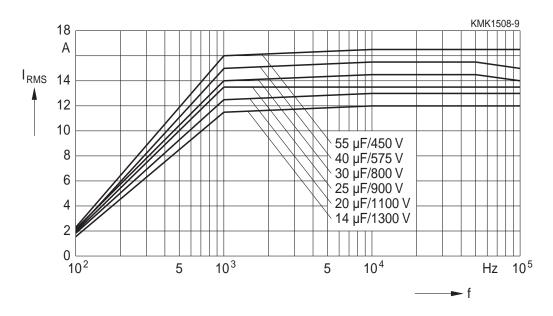


Lead spacing 52.5 mm

B32778G* (4 pins)



B32778T* (4 pins)





B32778

MKP DC link – high density series up to 480 μ F

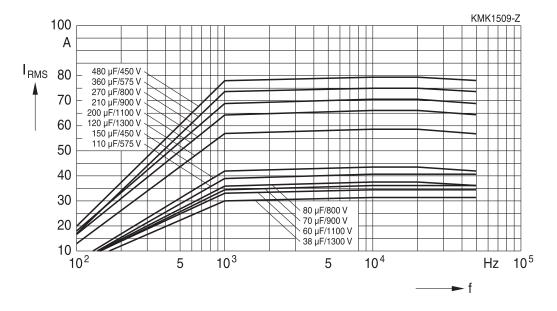
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C



Lead spacing 52.5 mm

B32778J* (12 pins)

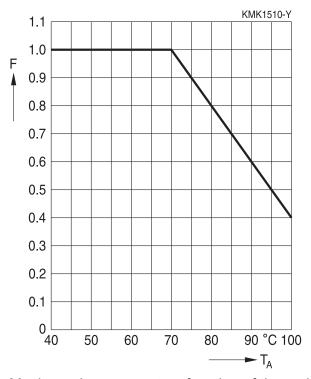




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MKP DC link – high density series up to 480 μ F

Curves characteristics (I_{RMS} derating versus temperature)



Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_A) = Factor x I_{RMS} (70 °C)

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MKP DC link - high density series up to 480 µF

Heat transference for self heating calculation

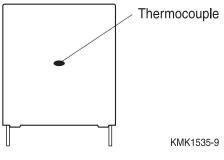


Figure 1

Box dimer	nsions		Equivalent heat coefficient
w (mm)	h (mm)	I (mm)	G (mW/°C)
11.0	19.0	31.5	25
11.0	21.0	31.5	28
12.5	21.5	31.5	30
13.5	23.0	31.5	32
14.0	24.5	31.5	35
15.0	24.5	31.5	36
16.0	32.0	31.5	45
18.0	27.5	31.5	44
18.0	33.0	31.5	48
19.0	30.0	31.5	48
20.0	11.0	31.5	65
21.0	31.0	31.5	51
22.0	36.5	31.5	58
12.0	22.0	41.5	70
14.0	25.0	41.5	43
16.0	28.5	41.5	50
18.0	32.5	41.5	59
20.0	39.5	41.5	72
24.0	19.0	41.5	50
24.0	15.0	41.5	44
28.0	37.0	42.0	83
28.0	42.5	41.5	90
30.0	45.0	42.0	100
33.0	48.0	42.0	100
43.0	22.0	41.5	80
30.0	45.0	57.5	125
35.0	50.0	57.5	145
43.0	24.0	57.5	103
45.0	57.0	57.5	185
60.0	45.0	57.5	192
130.0	24.0	57.5	200
130.0	58.0	57.5	300

The equivalent heat coefficient "G (mW/°C)" is given for measuring the temperature on the lateral surface of the plastic box as Figure 1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.

MKP DC link - high density series up to 480 µF

Self Heating by power dissipation & equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per: ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per:

$$\Delta T_{\text{max}}(T) = (Factor)^2 \times \Delta T (70 \, ^{\circ}C).$$

For any particular I_{RMS} the ΔT may be calculated by:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G(mW/°C).

Where ΔT (°C) is the difference between the temperature measured on the box (see Figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T$$
 (°C) = T_{op} (°C) - T_{A} (°C).

It represents the increasing of temperature provoked by the I_{RMS} during operation.

G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by:

$$P_{dis}(mW) = ESR_{typ}(m\Omega) \times I_{RMS}^{2}(A_{RMS}).$$

Example for thermal calculation:

We will take as reference B32778G0306K (30 μ F/1100 V) type for thermal calculation. Considering the following load and capacitor characteristics:

 I_{RMS} : 12 A_{RMS} at 20 kHz T_A : 85 °C $30 \times 45 \times 57.5$ box

G (mW/°C): 125

Then we have to find the ESR_{tvp} at 20 kHz what is approx . 8.2 m Ω .

So according to:

$$P_{dis}(mW) = ESR_{typ}(m\Omega) \times I_{RMS^2}(A_{RMS})$$

we have the following:

$$P_{dis}$$
 (mW) = 8.2 m $\Omega \times 12 A_{RMS^2} = 1181 mW$

and as per:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G (mW/°C)

we have the following:

$$\Delta T$$
 (°C) = 1181 (mW) / 125 (mW/°C) = 9.5 °C.

What is below of the

$$\Delta T_{\text{max}}$$
 (85 °C) = (Factor)² × ΔT (70 °C) = (0.7)² × 20 °C = 9.8 °C.

On the other hand we may confirm that max I_{RMS} at 20 kHz at 70 °C = 17.5 A_{RMS}

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

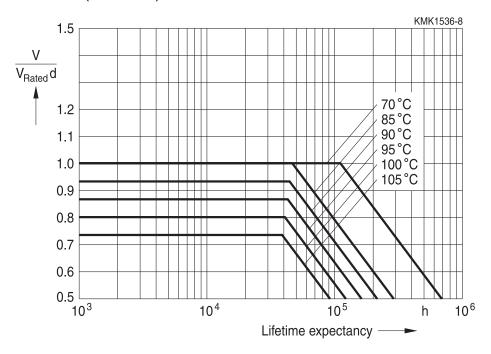
$$I_{RMS}$$
 (85 °C) = Factor × I_{RMS} (70 °C) = 0.7 × 17.5 A_{RMS} = 12.25 A_{RMS} .

What confirms once again that I_{RMS} (12 A_{RMS} at 20 kHz) is below the max specified for such frequency and ambient temperature.

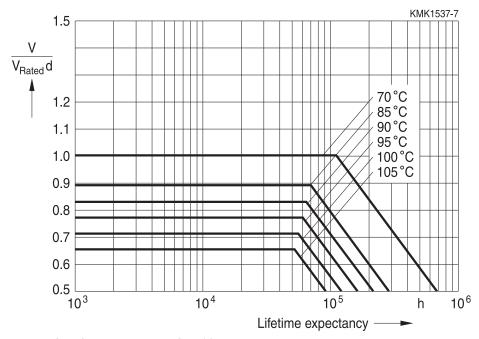
MKP DC link – high density series up to 480 μ F

Life time expectancy - typical curves

B3277x-4 (450 V DC)



B3277x-5/8/9/0/1 (575 V DC / 800 V DC / 900 V DC / 1100 V DC / 1300 V DC)



Note: Confidence level of 95%



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MKP DC link – high density series up to 480 μ F

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters (Routine test)	IEC61071:2007	Voltage between terminals, 1.5 V_R , during 10 s Insulation resistance, R_{ins} at V_R if $V_R < 500 \text{ V}$ or 500 V if $V_R \ge 500 \text{ V}$ Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan δ at 1/10 kHz (room temperature)		Within specified limits
Robustness of termina-tions	IEC 60068-2-21-2006	Tensile strength (to Wire diameter 0.5 <d₁ mm<="" td="" ≤0.8=""><td>est Ua1) Tensile force 10 N</td><td>Capacitance and tan δ within specified limits</td></d₁>	est Ua1) Tensile force 10 N	Capacitance and tan δ within specified limits
(Type test) Resistance to soldering heat	· ·	0.8 <d<sub>1 ≤1.25 mm 20 N Solder bath temperature at 260 ±5 °C, immersion for</d<sub>		Δ C/C ₀ ≤2% Δ tan δ ≤0.002
(Type test) Rapid change of temperature (Type test)	method 1A IEC 60384-16:2005	10 seconds T _A = lower category temperature T _B = upper category temperature Five cycles, duration t = 30 min		$ \Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.002$ R _{ins} ≥50% of initial limit
Vibration (Type test)	IEC 60384-16:2005	Test F _C : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump (Type test)	IEC 60384-16:2005	Test Eb: Total 4000 bumps with 390 m/s² mounted on PCB 6 ms duration		No visible damage $ \Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.002$ $R_{ins} \ge 50\%$ of initial limit
Climatic sequence (Type test)	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1st cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH		No visible damage $ \Delta C/C_0 \leq 3\%$ $ \Delta \tan \delta \leq 0.001$ $R_{ins} \geq 50\% \text{ of initial limit}$



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MKP DC link – high density series up to 480 μ F

Test	Reference	Conditions of test	Performance requirements
Damp heat, steady state (Type test)	IEC 60384-16:2005	Test Ca 40 °C / 93% RH / 56 days	No visible damage $ \Delta C/C_0 \le 5\%$ $ \Delta \tan \delta \le 0.005$ $R_{ins} \ge 50\%$ of initial limit
Endurance (Type test)	IEC 60384-16:2005	70 °C / 1.25 V_R / 1000 hours or 85 °C / 1.25 V_{op} / 1000 hours or 100 °C / 1.25 V_{op} / 1000 hours	No visible damage $ \Delta C/C_0 \le 5\%$ at 1 kHz $ \Delta$ tan δ ≤ 0.005 $R_{ins} \ge 50\%$ of initial limit



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MKP DC link - high density series up to 480 μF

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

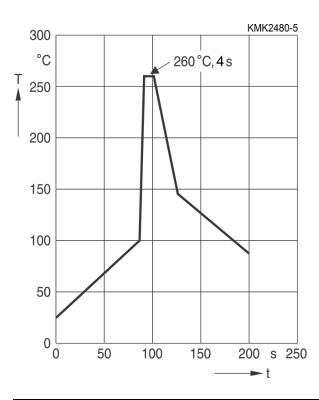
Solder bath temperature	235 ±5 °C	
Soldering time	2.0 ±0.5 s	
Immersion depth	2.0 +0/–0.5 mm from capacitor body or seating plane	
Evaluation criteria:		
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder	

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1. Conditions:

Series		Solder bath temperature	Soldering time
MKT	boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing >7.5 mm)		
MKT	boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP MKT	(lead spacing ≤7.5 mm) uncoated (lead spacing ≤10 mm) insulated (B32559)		<4 s recommended soldering profile for MKT uncoated (lead spacing ≤10 mm) and insulated (B32559)

MKP DC link – high density series up to 480 μ F



Immersion depth	2.0 +0/–0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 ± 0.5) mm thick, between capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors	
tan δ	As specified in sectional specification	

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

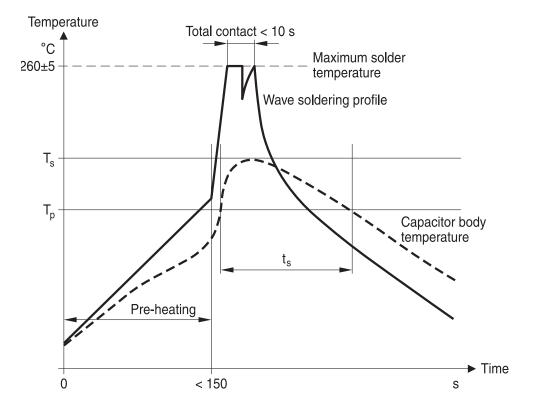
- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

MKP DC link – high density series up to 480 μ F

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

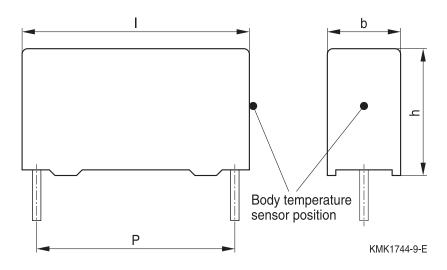
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s: Capacitor body maximum temperature at wave soldering

T_n: Capacitor body maximum temperature at pre-heating

KMK1745-A-E





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MKP DC link – high density series up to 480 μF

Body temperature should follow the description below:

■ MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: $T_p \le 125$ °C During soldering: $T_s \le 160$ °C, $t_s \le 45$ s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



Metallized polypropylene film capacitors (MKP)	B32774 B32778
MKP DC link – high density series up to 480 μF	

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"



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MKP DC link – high density series up to 480 μF

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.



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MKP DC link – high density series up to 480 μ F

Symbols and terms

Symbol		German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
βс	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
Δ C/C	Relative capacitance change	Relative Kapazitätsänderung
	(relative deviation of actual value)	(relative Abweichung vom Ist-Wert)
Δ C/C _R	Capacitance tolerance	Kapazitätstoleranz
	(relative deviation from rated capacitance)	(relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
Δ tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function	Differentielle Spannungsänderung
	(rate of voltage rise)	(Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechsel- spannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Redu- zierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F_{D}	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F _T	Derating factor	Deratingfaktor
İ	Current (peak)	Stromspitze
I_{C}	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)
I _{RMS}	(Sinusoidal) alternating current, root-mean- square value	(Sinusförmiger) Wechselstrom
i _z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
L _S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase



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MKP DC link – high density series up to 480 μ F

Symbol	English	German
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$tan \ \delta$	Dissipation factor	Verlustfaktor
$tan \; \delta_{\text{D}}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$tan \; \delta_{\text{P}}$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_{S}	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the com-	Temperatur der Luft, die das Bauteil um-
	ponent	gibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and	Betriebszeit bei Betriebstemperatur und
_	voltage	-spannung
T _{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer
V _{AC}	AC voltage	Wechselspannung
V _C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V _{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V _{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V _{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V _i	Input voltage	Eingangsspannung
V _o	Output voltage	Ausgangssspannung
V _{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub



Metallized polypropylene film capacitors (MKP) MKP DC link – high density series up to 480 μF

Symbol	English	German
$\overline{V_R}$	Rated voltage	Nennspannung
\hat{V}_R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean- square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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